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Appl. No. TBD Preliminary Amdt. Dated April 6, 2006 Reply to Office action of N/A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.

TBD

Applicant

: Yuichiro Sasaki et al.

Filed

Herewith

Title

"METHOD FOR MAKING JUNCTION AND PROCESSED

MATERIAL FORMED USING THE SAME"

Confirmation No.

TBD

TC/A.U.

TBD

Examiner

TBD

International App. No.:

PCT/JP2004/015308

International Flg. Date:

October 8, 2004

Customer No.

52054

Docket No.

40201

Mail Stop PCT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT "A"

Sir:

Please amend the above-identified application, prior to examination thereof, in the following manner.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.

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